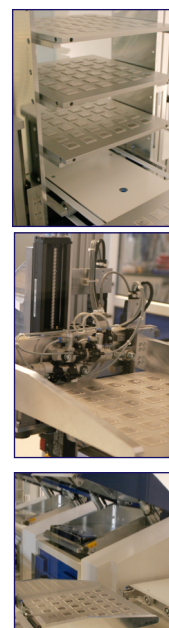


# VS 320i

## Vacuum Soldering Systems

**budatec**®  
Equipment for semiconductor and photovoltaic industries



Technical Data:	numbers of soldering modules	2 up to 6
	plate size:	320mm x 320mm
	max. substrate height:	100mm
	max. solder temperature:	400°C
	heat up / cool down:	max. 2,5K/s
	max. load:	15kg
	possible process gases:	N <sub>2</sub> ; N <sub>2</sub> H <sub>2</sub> 95/5% H <sub>2</sub> bis 100%

Optionen:

- storage system for workpiece carriers
- formic acid gas line with bubbler
- maximum of 5 gas lines
- initgrated plasma equipment
- high vacuum pump

**Made in Germany**

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08/2018 reserve modifications;

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